

### IRF620 IRF620FI

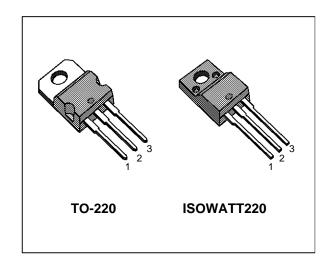
# N - CHANNEL ENHANCEMENT MODE POWER MOS TRANSISTORS

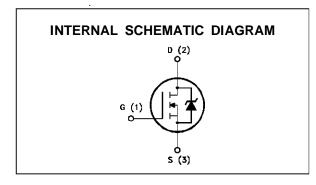
| TYPE     | V <sub>DSS</sub> | R <sub>DS(on)</sub> | Ι <sub>D</sub> |
|----------|------------------|---------------------|----------------|
| IRF620   | 200 V            | < 0.8 Ω             | 6 A            |
| IRF620FI | 200 V            | < 0.8 Ω             | 4 A            |

- TYPICAL  $R_{DS(on)} = 0.55 \Omega$
- AVALANCHE RUGGED TECHNOLOGY
- 100% AVALANCHE TESTED
- REPETITIVE AVALANCHE DATA AT 100°C

#### **APPLICATIONS**

- HIGH CURRENT, HIGH SPEED SWITCHING
- UNINTERRUPTIBLE POWER SUPPLY (UPS)
- MOTOR CONTROL, AUDIO AMPLIFIERS
- INDUSTRIAL ACTUATORS
- DC-DC & DC-AC CONVERTERS FOR TELECOM, INDUSTRIAL AND CONSUMER ENVIRONMENT





#### ABSOLUTE MAXIMUM RATINGS

| Symbol              | Parameter   | Va         | Value    |      |  |  |
|---------------------|---|------------|----------|------|--|--|
|                     |   | IRF620     | IRF620FI |      |  |  |
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)            | 20         | 00       | V    |  |  |
| $V_{DGR}$           | Drain- gate Voltage ( $R_{GS} = 20 \text{ k}\Omega$ ) | 20         | 00       | V    |  |  |
| V <sub>G</sub> S    | Gate-source Voltage                                   | ± :        | 20       | V    |  |  |
| I <sub>D</sub>      | Drain Current (cont.) at T <sub>c</sub> = 25 °C       | 6 4        |          | Α    |  |  |
| I <sub>D</sub>      | Drain Current (cont.) at T <sub>c</sub> = 100 °C      | 4          | 2        | Α    |  |  |
| I <sub>DM</sub> (•) | Drain Current (pulsed)                                | 24         | 24       | А    |  |  |
| P <sub>tot</sub>    | Total Dissipation at T <sub>c</sub> = 25 °C           | 70         | 30       | W    |  |  |
|                     | Derating Factor                                       | 0.56       | 0.24     | W/°C |  |  |
| V <sub>ISO</sub>    | Insulation Withstand Voltage (DC)                     |            |          | V    |  |  |
| T <sub>stg</sub>    | Storage Temperature                                   | -65 to 150 |          | °C   |  |  |
| Tj                  | Max. Operating Junction Temperature                   | 15         | 50       | °C   |  |  |

(•) Pulse width limited by safe operating area

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#### THERMAL DATA

|  |  |                     | TO-220        | ISOWATT220 |                    |
|--|--|---------------------|---------------|------------|--------------------|
| R <sub>thj-case</sub>  | Thermal Resistance Junction-case   | Max                 | 1.79          | 4.17       | °C/W               |
| R <sub>thj-amb</sub><br>R <sub>thc-s</sub><br>T <sub>I</sub> | Thermal Resistance Junction-ambient Thermal Resistance Case-sink Maximum Lead Temperature For Soldering Pu | Max<br>Typ<br>rpose | 62<br>0<br>30 | .5         | °C/W<br>°C/W<br>°C |

#### **AVALANCHE CHARACTERISTICS**

| Symbol          | Parameter   | Max Value | Unit |
|-----------------|---|-----------|------|
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max, $\delta$ < 1%)   | 6         | А    |
| E <sub>AS</sub> | Single Pulse Avalanche Energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 25$ V)  | 20        | mJ   |
| E <sub>AR</sub> | Repetitive Avalanche Energy (pulse width limited by $T_j$ max, $\delta$ < 1%)   | 5         | mJ   |
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive $(T_c = 100  ^{\circ}\text{C}, \text{ pulse width limited by } T_j \text{ max, } \delta < 1\%)$ | 4         | А    |

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ $^{o}C$ unless otherwise specified) OFF

| Symbol               | Parameter  | Test Conditions  | Min. | Тур. | Max.        | Unit     |
|----------------------|--|--|------|------|-------------|----------|
| V <sub>(BR)DSS</sub> | Drain-source<br>Breakdown Voltage                        | $I_D = 250 \mu\text{A}$ $V_{GS} = 0$                                       | 200  |      |             | <b>\</b> |
| I <sub>DSS</sub>     | Zero Gate Voltage<br>Drain Current (V <sub>GS</sub> = 0) | $V_{DS}$ = Max Rating $V_{DS}$ = Max Rating x 0.8 $T_c$ = 125 $^{\circ}$ C |      |      | 250<br>1000 | μA<br>μA |
| I <sub>GSS</sub>     | Gate-body Leakage<br>Current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 20 V   |      |      | ± 100       | nA       |

#### ON (\*)

| Symbol              | Parameter                         | Test Conditions                                    | Min. | Тур. | Max. | Unit |
|---------------------|-----------------------------------|--|------|------|------|------|
| V <sub>GS(th)</sub> | Gate Threshold Voltage            | $V_{DS} = V_{GS}$ $I_D = 250 \mu A$                | 2    | 3    | 4    | V    |
| R <sub>DS(on)</sub> | Static Drain-source On Resistance | $V_{GS} = 10V$ $I_D = 3$ A                         |      | 0.55 | 0.8  | Ω    |
| I <sub>D(on)</sub>  | On State Drain Current            | $V_{DS} > I_{D(on)} x R_{DS(on)max} V_{GS} = 10 V$ | 6    |      |      | Α    |

#### **DYNAMIC**

| Symbol               | Parameter  | Test Conditions                                       | Min. | Тур.            | Max.             | Unit           |
|----------------------|--|---|------|-----------------|------------------|----------------|
| g <sub>fs</sub> (*)  | Forward<br>Transconductance  | $V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 3 A$ | 1.5  | 3.5             |                  | S              |
| Ciss<br>Coss<br>Crss | Input Capacitance<br>Output Capacitance<br>Reverse Transfer<br>Capacitance | V <sub>DS</sub> = 25 V f = 1 MHz V <sub>GS</sub> = 0  |      | 460<br>90<br>20 | 600<br>120<br>30 | pF<br>pF<br>pF |



#### **ELECTRICAL CHARACTERISTICS** (continued)

#### SWITCHING RESISTIVE LOAD

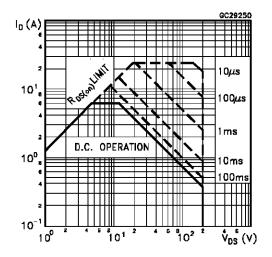
| Symbol   | Parameter   | Test Conditions   | Min. | Тур.                  | Max.                   | Unit                 |
|--|---|---|------|-----------------------|------------------------|----------------------|
| $t_{ m d(on)} \ t_{ m r} \ t_{ m d(off)} \ t_{ m f}$ | Turn-on Time<br>Rise Time<br>Turn-off Delay Time<br>Fall Time | $V_{DD} = 100 \text{ V}$ $I_D = 3 \text{ A}$ $R_G = 50 \Omega$ $V_{GS} = 10 \text{ V}$ (see test circuit) |      | 30<br>70<br>135<br>45 | 45<br>100<br>190<br>65 | ns<br>ns<br>ns<br>ns |
| $egin{array}{c} Q_{g} \ Q_{gs} \ Q_{gd} \end{array}$ | Total Gate Charge<br>Gate-Source Charge<br>Gate-Drain Charge  | $I_D = 6 \text{ A}  V_{GS} = 10 \text{ V}$<br>$V_{DD} = \text{Max Rating x 0.8}$<br>(see test circuit)    |      | 20<br>6<br>8          | 30                     | nC<br>nC<br>nC       |

#### SOURCE DRAIN DIODE

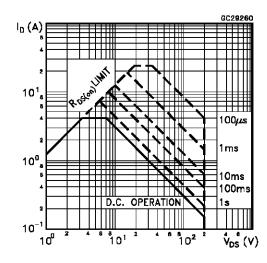
| Symbol                                  | Parameter  | Test Conditions                           | Min. | Тур. | Max.    | Unit   |
|---|--|---|------|------|---------|--------|
| I <sub>SD</sub><br>I <sub>SDM</sub> (•) | Source-drain Current<br>Source-drain Current<br>(pulsed) |   |      |      | 6<br>24 | A<br>A |
| V <sub>SD</sub> (*)                     | Forward On Voltage                                       | I <sub>SD</sub> = 6 A V <sub>GS</sub> = 0 |      |      | 1.5     | V      |
| t <sub>rr</sub>                         | Reverse Recovery<br>Time                                 | $I_{SD} = 6 \text{ A}$                    |      | 170  |         | ns     |
| $Q_{rr}$                                | Reverse Recovery<br>Charge                               | ,   |      | 1    |         | μС     |

<sup>(\*)</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %

#### Safe Operating Area for TO-220



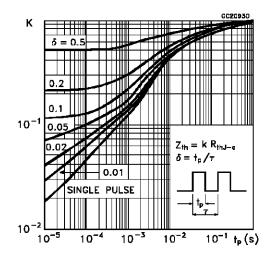
#### Safe Operating Area for ISOWATT220



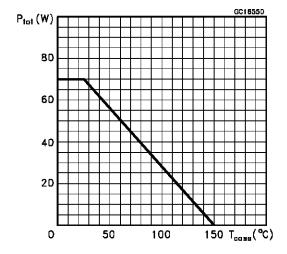


<sup>(•)</sup> Pulse width limited by safe operating area

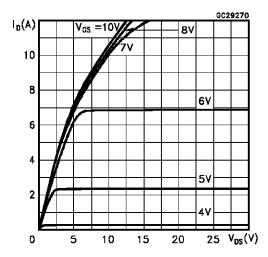
#### Thermal Impedance for TO-220



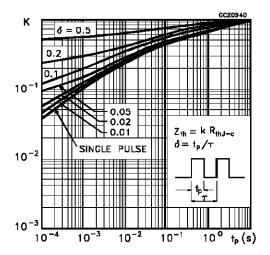
#### Derating Curve for TO-220



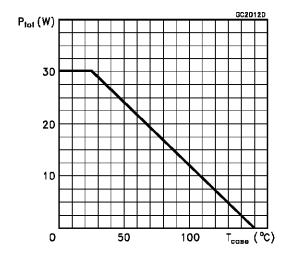
**Output Characteristics** 



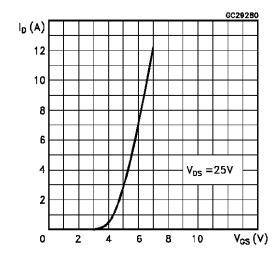
#### Thermal Impedance for ISOWATT220



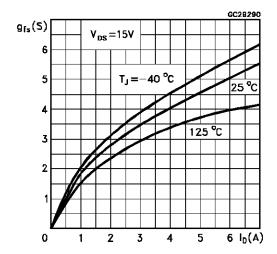
#### Derating Curve for ISOWATT220



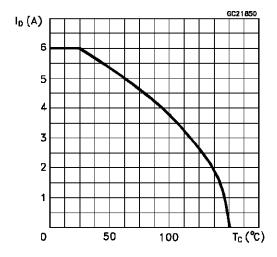
**Transfer Characteristics** 



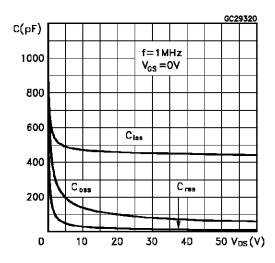
#### Transconductance



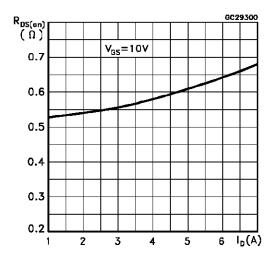
#### Maximum Drain Current vs Temperature



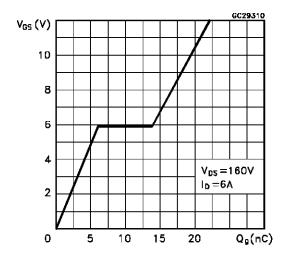
#### Capacitance Variations



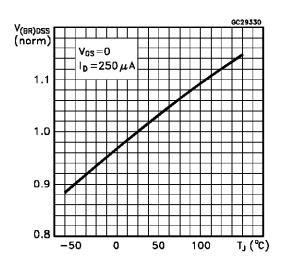
#### Static Drain-source On Resistance



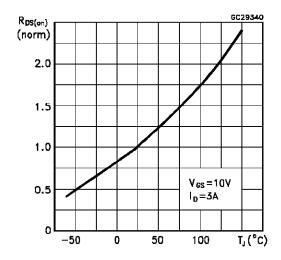
Gate Charge vs Gate-source Voltage



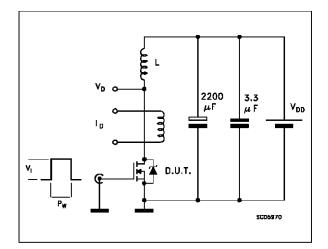
Normalized Breakdown Voltage vs Temperature



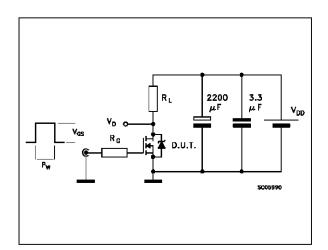
#### Normalized On Resistance vs Temperature



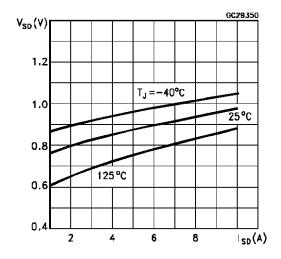
**Unclamped Inductive Load Test Circuit** 



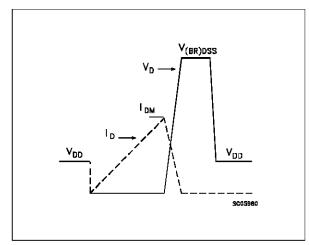
Switching Time Test Circuit



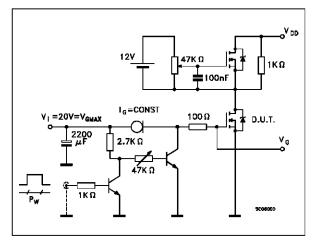
Source-drain Diode Forward Characteristics



**Unclamped Inductive Waveforms** 

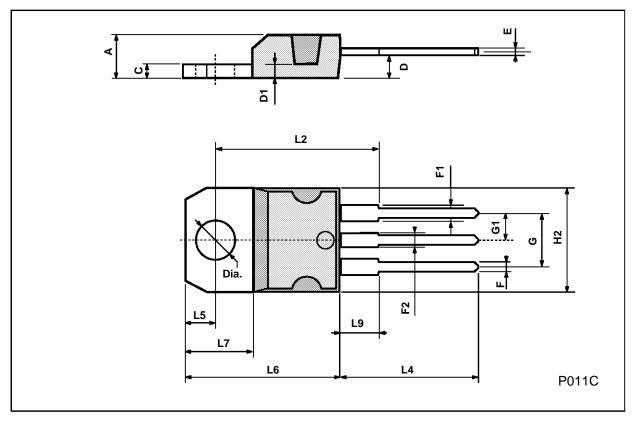


Gate Charge Test Circuit



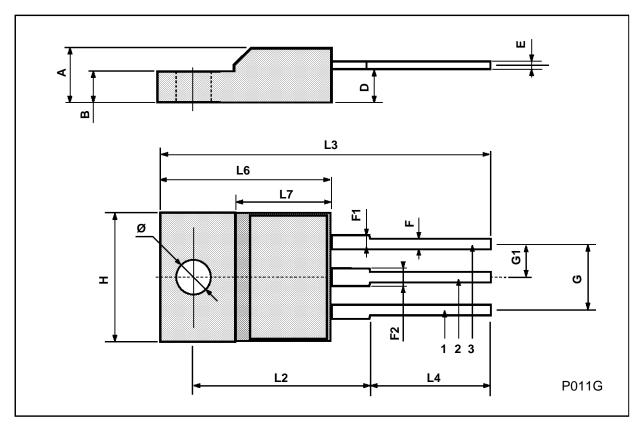
#### **TO-220 MECHANICAL DATA**

| DIM.   |       | mm   |       |       | inch  |       |
|--------|-------|------|-------|-------|-------|-------|
| DIIVI. | MIN.  | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| Α      | 4.40  |      | 4.60  | 0.173 |       | 0.181 |
| С      | 1.23  |      | 1.32  | 0.048 |       | 0.051 |
| D      | 2.40  |      | 2.72  | 0.094 |       | 0.107 |
| D1     |       | 1.27 |       |       | 0.050 |       |
| E      | 0.49  |      | 0.70  | 0.019 |       | 0.027 |
| F      | 0.61  |      | 0.88  | 0.024 |       | 0.034 |
| F1     | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| F2     | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| G      | 4.95  |      | 5.15  | 0.194 |       | 0.203 |
| G1     | 2.4   |      | 2.7   | 0.094 |       | 0.106 |
| H2     | 10.0  |      | 10.40 | 0.393 |       | 0.409 |
| L2     |       | 16.4 |       |       | 0.645 |       |
| L4     | 13.0  |      | 14.0  | 0.511 |       | 0.551 |
| L5     | 2.65  |      | 2.95  | 0.104 |       | 0.116 |
| L6     | 15.25 |      | 15.75 | 0.600 |       | 0.620 |
| L7     | 6.2   |      | 6.6   | 0.244 |       | 0.260 |
| L9     | 3.5   |      | 3.93  | 0.137 |       | 0.154 |
| DIA.   | 3.75  |      | 3.85  | 0.147 |       | 0.151 |



#### **ISOWATT220 MECHANICAL DATA**

| DIM.   |      | mm   |      |       | inch  |       |
|--------|------|------|------|-------|-------|-------|
| Dilvi. | MIN. | TYP. | MAX. | MIN.  | TYP.  | MAX.  |
| Α      | 4.4  |      | 4.6  | 0.173 |       | 0.181 |
| В      | 2.5  |      | 2.7  | 0.098 |       | 0.106 |
| D      | 2.5  |      | 2.75 | 0.098 |       | 0.108 |
| E      | 0.4  |      | 0.7  | 0.015 |       | 0.027 |
| F      | 0.75 |      | 1    | 0.030 |       | 0.039 |
| F1     | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| F2     | 1.15 |      | 1.7  | 0.045 |       | 0.067 |
| G      | 4.95 |      | 5.2  | 0.195 |       | 0.204 |
| G1     | 2.4  |      | 2.7  | 0.094 |       | 0.106 |
| Н      | 10   |      | 10.4 | 0.393 |       | 0.409 |
| L2     |      | 16   |      |       | 0.630 |       |
| L3     | 28.6 |      | 30.6 | 1.126 |       | 1.204 |
| L4     | 9.8  |      | 10.6 | 0.385 |       | 0.417 |
| L6     | 15.9 |      | 16.4 | 0.626 |       | 0.645 |
| L7     | 9    |      | 9.3  | 0.354 |       | 0.366 |
| Ø      | 3    |      | 3.2  | 0.118 |       | 0.126 |



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